

In the Specification:**Please amend paragraph [0020] as follows:**

[0020] The ceramic layer 2 is for example made of aluminum oxide, Al_2O_3 , Al_2O_3 , or aluminum nitride (AlN) Other ceramics, for example Si_3N_4 , SiC, BeO, TiO_2 , ZrO_2 or Al_2O_3 , Al_2O_3 containing ZrO_2 , for example between 5-30 percent by weight, and mullite ($3\text{-}\text{Al}_2\text{O}_3$, Al_2O_3 x 2 silicon oxide) are also conceivable.

Please amend paragraph [0023] as follows:

[0023] A special feature of the method according to the invention is the production of the separating or break-off lines 6 and 7 in the ceramic layer 2. This special processing step, which is also referred to as thermal processing, is depicted in Figures 2 - 4 and consists essentially in the fact that the ceramic layer 2 is progressively heated and then shock-cooled partially and linearly, thus producing - along the entire processing line or separating and break-off line - a controlled weakening of material or fracture between the top side and bottom side of the ceramic layer 2 within 2 within the ceramic layer through mechanical tensions, which occur during heating and subsequent cooling, as shown at 8 in Figure 4.